

TOSHIBA Phototransistor Silicon NPN Epitaxial Planar

TPS610(F)

Lead(Pb)-Free
Photoelectric Counter
Various Kinds Of Readers
Position Detection

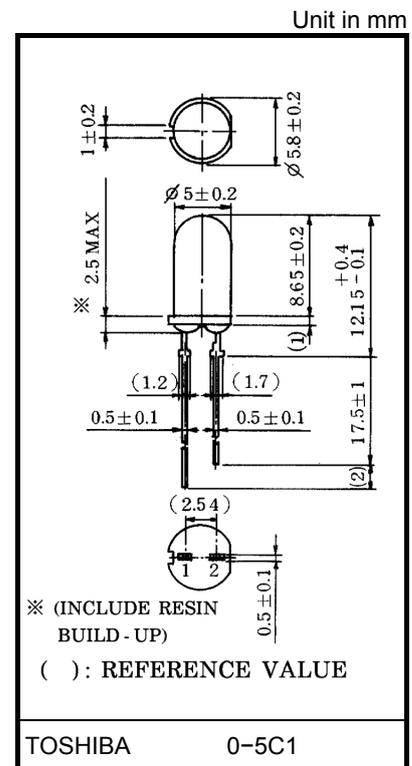
- $\phi 5$ mm epoxy resin package
- High sensitivity: $I_L = 250\mu A$ (typ.)
- Half value angle: $\theta_{1/2} = \pm 8^\circ$ (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Collector-emitter voltage	V_{CEO}	30	V
Emitter-collector voltage	V_{ECO}	5	V
Collector Current	I_C	50	mA
Collector power dissipation	PC	-150	mW
Collector power dissipation derating (Ta>25°C)	$\Delta P_C / ^\circ C$	-2	mW / °C
Operating temperature range	T_{opr}	-20~75	°C
Storage temperature range	T_{stg}	-30~100	°C

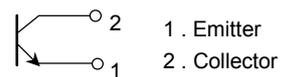
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



Weight: 0.3g (typ.)

Pin Connection



Opto-Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Dark current	$I_D (I_{CEO})$	$V_{CE} = 24V, E = 0$	—	0.005	0.1	μA
Light current	I_L	$V_{CE} = 3V, E = 0.1mW / cm^2$ (Note)	100	250	—	μA
Collector-emitter saturation voltage	$V_{CE (sat)}$	$I_C = 50\mu A, E = 0.1mW / cm^2$ (Note)	—	0.25	0.4	V
Switching time	Rise time	$V_{CC} = 5V, I_C = 2mA$ $R_L = 100\Omega$	—	6	—	μs
	Fall time		—	6	—	
Peak sensitivity wavelength	λ_P	—	—	800	—	nm
Half value angle	$\theta_{\frac{1}{2}}$	—	—	± 8	—	°

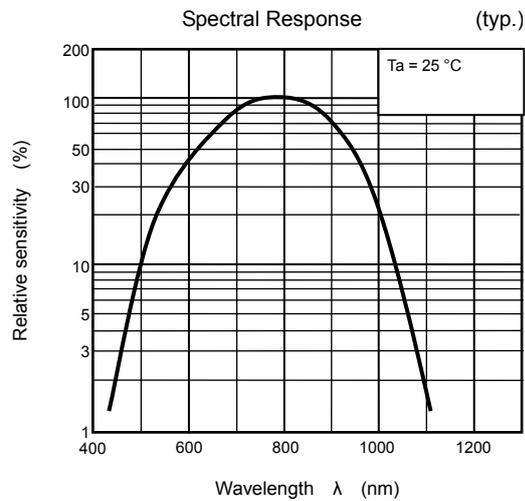
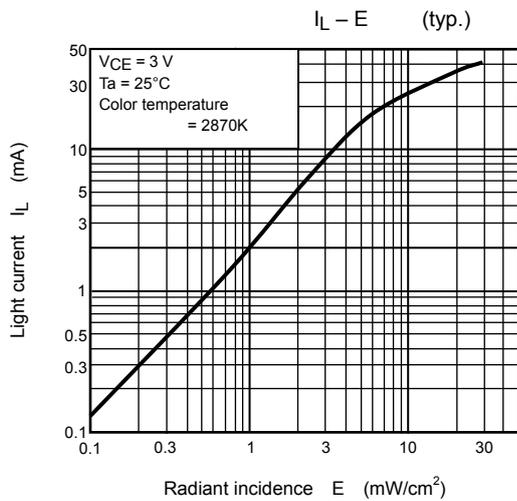
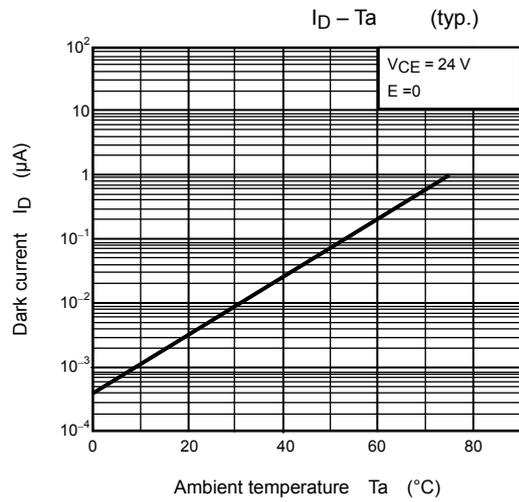
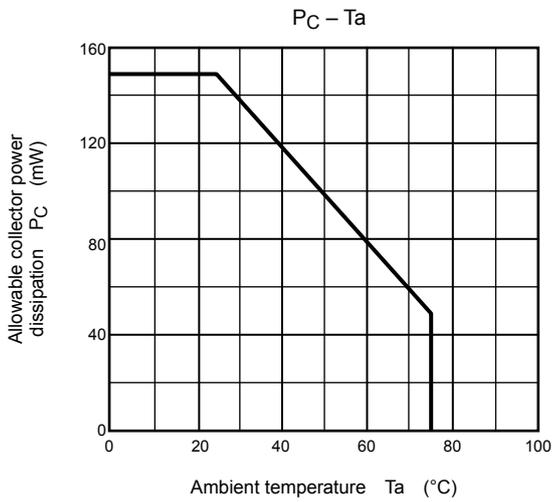
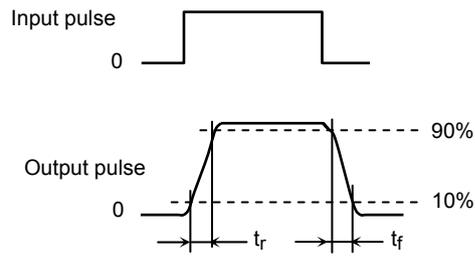
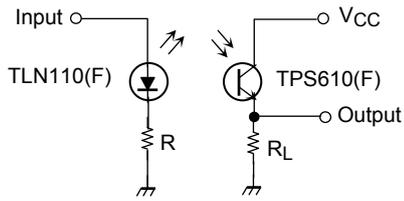
Note: Color temperature = 2870K, standard tungsten lamp

Precaution

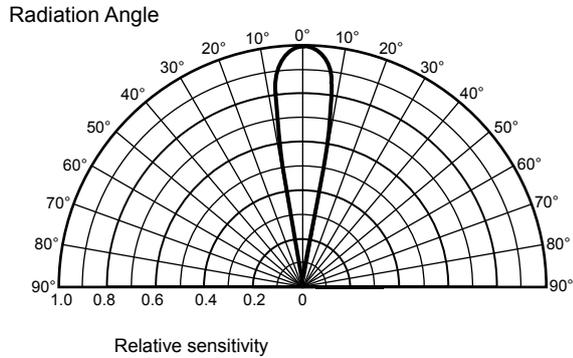
Please be careful of the followings.

1. Soldering shall be performed at the top portion from the lead stopper.
2. Soldering temperature: 260°C max. Soldering time: 5s max.
3. When the lead is formed, the lead shall be formed at the top portion of the stopper without leaving forming stress to the body of the device. Soldering shall be performed after lead forming.

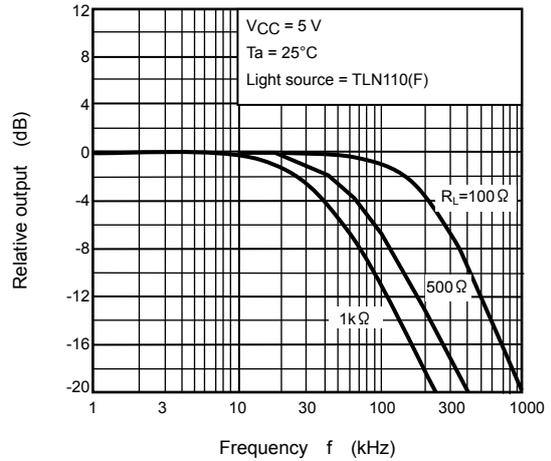
Fig.1 Switching time test circuit



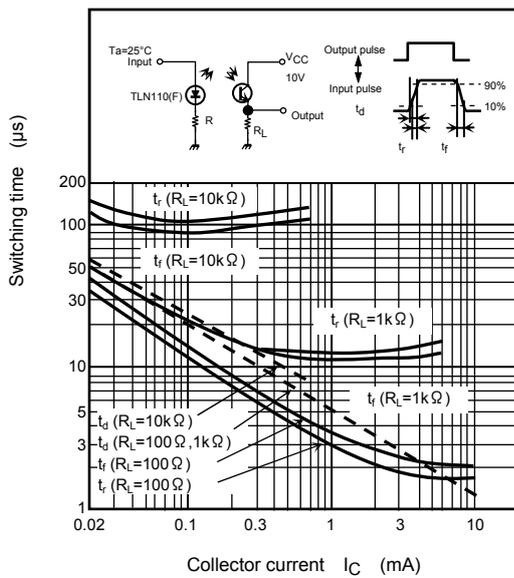
Directional Sensitivity Characteristic (typ.)
($T_a = 25^\circ\text{C}$)



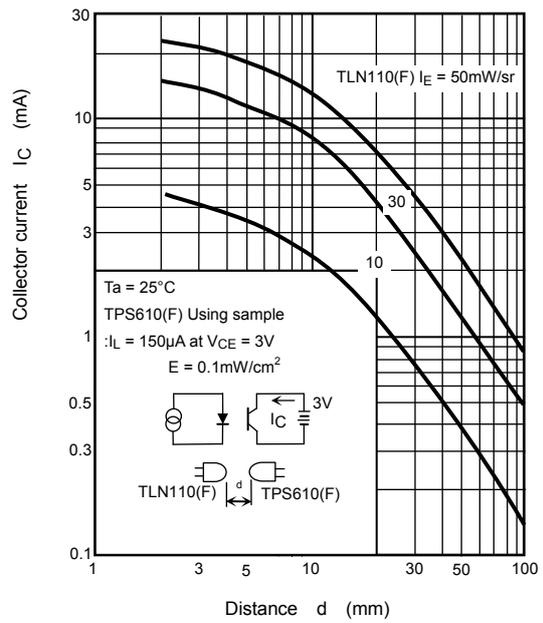
Frequency Characteristics (typ.)



Switching Characteristics (typ.)



Coupling Characteristics With TLN110(F)



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20070701-EN GENERAL

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